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Details

Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	25
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.25К х 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.25V
Data Converters	A/D 25x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	32-VFQFN Exposed Pad
Supplier Device Package	32-QFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f541-imr

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C8051F54x



Figure 4.6. QFN-24 Landing Diagram

Table 4.6. QFN-24 Landing	Diagram Dimensions
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Dimension	Min	Max	Dimension	Min	Max
C1	3.90	4.00	X2	2.70	2.80
C2	3.90	4.00	Y1	0.65	0.75
E 0.50 BSC		Y2	2.70	2.80	
X1	0.20	0.30			

Notes:

General

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. This Land Pattern Design is based on the IPC-7351 guidelines.

Solder Mask Design

3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.

Stencil Design

- **4.** A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 5. The stencil thickness should be 0.125 mm (5 mils).
- 6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
- **7.** A 2x2 array of 1.10 mm x 1.10 mm openings on a 1.30 mm pitch should be used for the center ground pad.

Card Assembly

- 8. A No-Clean, Type-3 solder paste is recommended.
- **9.** The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.



SFR Definition 5.4. ADC0CF: ADC0 Configuration

Bit	7	6	5	4	3	2	1	0
Name			AD0SC[4:0]	ADORI	PT[1:0]	GAINEN		
Туре			R/W		R/W	R/W	R/W	
Reset	1	1	1	1	1	0	0	0

SFR Address = 0xBC; SFR Page = 0x00

Bit	Name	Function
7:3	AD0SC[4:0]	ADC0 SAR Conversion Clock Period Bits.
		SAR Conversion clock is derived from system clock by the following equation, where <i>ADOSC</i> refers to the 5-bit value held in bits ADOSC4–0. SAR Conversion clock requirements are given in the ADC specification table BURSTEN = 0: FCLK is the current system clock BURSTEN = 1: FCLK is a maximum of 30 MHz, independent of the current system clock
		$AD0SC = \frac{FCLK}{CLK_{SAR}} - 1$
		Note: Round up the result of the calculation for AD0SC
2:1	A0RPT[1:0]	ADC0 Repeat Count
		Controls the number of conversions taken and accumulated between ADC0 End of Conversion (ADCINT) and ADC0 Window Comparator (ADCWINT) interrupts. A con- vert start is required for each conversion unless Burst Mode is enabled. In Burst Mode, a single convert start can initiate multiple self-timed conversions. Results in both modes are accumulated in the ADC0H:ADC0L register. When AD0RPT1–0 are set to a value other than '00', the AD0LJST bit in the ADC0CN register must be set to '0' (right justified). 00: 1 conversion is performed. 01: 4 conversions are performed and accumulated. 10: 8 conversions are performed and accumulated. 11: 16 conversions are performed and accumulated.
0	GAINEN	Gain Enable Bit.
		Controls the gain programming. Refer to Section "5.3. Selectable Gain" on page 35 for information about using this bit.



6.1. ADC0 Analog Multiplexer

ADC0 includes an analog multiplexer to enable multiple analog input sources. Any of the following may be selected as an input: P0.0–P3.0, the on-chip temperature sensor, the core power supply (V_{DD}), or ground (GND). **ADC0 is single-ended and all signals measured are with respect to GND.** The ADC0 input channels are selected using the ADC0MX register as described in SFR Definition 6.3.



Figure 6.2. ADC0 Multiplexer Block Diagram

Important Note About ADC0 Input Configuration: Port pins selected as ADC0 inputs should be configured as analog inputs, and should be skipped by the Digital Crossbar. To configure a Port pin for analog input, set to 0 the corresponding bit in register PnMDIN. To force the Crossbar to skip a Port pin, set to 1 the corresponding bit in register PnSKIP. See Section "18. Port Input/Output" on page 147 for more Port I/O configuration details.



8.1. Comparator Multiplexer

C8051F54x devices include an analog input multiplexer for each of the comparators to connect Port I/O pins to the comparator inputs. The Comparator0 inputs are selected in the CPT0MX register (SFR Definition 8.5). The CMX0P3–CMX0P0 bits select the Comparator0 positive input; the CMX0N3–CMX0N0 bits select the Comparator0 negative input. Similarly, the Comparator1 inputs are selected in the CPT1MX register using the CMX1P3-CMX1P0 bits and CMX1N3-CMX1N0 bits. The same pins are available to both multiplexers at the same time and can be used by both comparators simultaneously.

Important Note About Comparator Inputs: The Port pins selected as comparator inputs should be configured as analog inputs in their associated Port configuration register, and configured to be skipped by the Crossbar (for details on Port configuration, see Section "18.6. Special Function Registers for Accessing and Configuring Port I/O" on page 161).







dress	ade	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)
Ade	۵								
F8	0 F	SPI0CN	PCA0L SN0	PCA0H SN1	PCA0CPL0 SN2	PCA0CPH0 SN3	PCACPL4	PCACPH4	VDM0CN
F0	0	В	POMAT	POMASK	P1MAT	P1MASK		EIP1	EIP2
-	F	(All Pages)	POMDIN	P1MDIN	P2MDIN	P3MDIN		EIP1	EIP2
E8	0 F	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2	PCA0CPL3	PCA0CPL3	RSTSRC
E0	0	ACC						EIE1	EIE2
	F	(All Pages)	XBR0	XBR1	CCH0CN	IT01CF		(All Pages)	(All Pages)
D8	0 F	PCA0CN	PCA0MD PCA0PWM	PCA0CPM0	PCA0CPM1	PCA0CPM2	PCA0CPM3	PCA0CPM4	PCA0CPM5
D0	0	PSW	REF0CN	LIN0DATA	LIN0ADDR				
	F	(All Pages)				P0SKIP	P1SKIP	P2SKIP	P3SKIP
C8	0 F	TMR2CN	REG0CN LIN0CF	TMR2RLL	TMR2RLH	TMR2L	TMR2H	PCA0CPL5	PCA0CPH5
C0	0 F	SMB0CN	SMB0CF	SMB0DAT	ADC0GTL	ADC0GTH	ADC0LTL	ADC0LTH	XBR2
B8	0 F	IP (All Pages)		ADC0TK	ADC0MX	ADC0CF	ADC0L	ADC0H	
B0	0	P3	P2MAT	P2MASK				FLSCL	FLKEY
	F	(All Pages)						(All Pages)	(All Pages)
A8	0	IE	SMOD0	EMI0CN				P3MAT	P3MASK
	F	(All Pages)			SBCON0	SBRLL0	SBRLH0	P3MDOUT	
A0	0	P2	SPI0CFG	SPI0CKR	SPI0DAT				SFRPAGE
	F	(All Pages)	OSCICN	OSCICRS		POMDOUT	P1MDOUT	P2MDOUT	(All Pages)
98	0	SCON0	SBUF0	CPT0CN	CPT0MD	CPT0MX	CPT1CN	CPT1MD	CPT1MX
	F							OSCIFIN	OSCXCN
90	0	P1	TMR3CN	TMR3RLL	TMR3RLH	TMR3L	TMR3H		
~~		(All Pages)	THOD	TIO	T L 4	TUO	TUA		
88									
00			(All Payes)			(All Pages)	(All Pages)	(All Pages)	
00	F	(All Pages)	(All Pages)	(All Pages)	(All Pages)	SFR0CN		(All Pages)	(All Pages)
		0(8)	(, 1 (g00) 1(9)	(, (ugoo) 2(A)	., (agoo) 3(B)	4(C)	5(D)	(, , ugoo) 6(F)	7(F)
		(bit address	sable)	-(* ')	-(-)	.(•)		•(=)	. (•)

Table 12.1. Special Function Register (SFR) Memory Map for Pages 0x0 and 0xF



SFR Definition 13.6. EIP2: Extended Interrupt Priority Enabled 2

Bit	7	6	5	4	3	2	1	0
Name						PMAT		PREG0
Туре	R	R	R	R	R	R/W	R	R/W
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xF7; SFR Page = 0x00 and 0x0F

Bit	Name	Function
7:3	Unused	Read = 00000b; Write = Don't Care.
2	PMAT	Port Match Interrupt Priority Control. This bit sets the priority of the Port Match interrupt. 0: Port Match interrupt set to low priority level. 1: Port Match interrupt set to high priority level.
1	Unused	Read = 0b; Write = Don't Care.
0	PREG0	 Voltage Regulator Dropout Interrupt Priority Control. This bit sets the priority of the Voltage Regulator Dropout interrupt. 0: Voltage Regulator Dropout interrupt set to low priority level. 1: Voltage Regulator Dropout interrupt set to high priority level.



Bit	7	6	5	4	3	2	1	0
Nam	e Reserved	Reserved	CHPFEN	Reserved	Reserved	Reserved	Reserved	CHBLKW
Туре	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Rese	t 0	0	1	0	0	0	0	0
SFR A	ddress = 0xE	3; SFR Page	e = 0x0F					
Bit	Name				Function			
7:6	Reserved	Must Write 0	0b					
5	CHPFEN	Cache Prefe	ect Enable E	Bit.				
		0: Prefetch e	ngine is disa	abled.				
		1: Prefetch e	ngine is ena	bled.				
4:1	Reserved	Must Write 0	000b.					
0	CHBLKW	Block Write Enable Bit.						
		This bit allow	s block write	es to Flash n	nemory from	firmware.		
		0: Each byte	of a softwar	e Flash write	e is written ir	ndividuallv.		

1: Flash bytes are written in groups of two.

SFR Definition 14.5. ONESHOT: Flash Oneshot Period

Bit	7	6	5	4	3	2	1	0
Name					PERIOD[3:0]			
Туре	R	R	R	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	1	1	1	1

SFR Address = 0xBE; SFR Page = 0x0F

Bit	Name	Function
7:4	Unused	Read = 0000b. Write = don't care.
3:0	PERIOD[3:0]	Oneshot Period Control Bits. These bits limit the internal Flash read strobe width as follows. When the Flash read strobe is de-asserted, the Flash memory enters a low-power state for the remainder of the system clock cycle. $FLASH_{RDMAX} = 5ns + (PERIOD \times 5ns)$



15.2. Stop Mode

Setting the Stop Mode Select bit (PCON.1) causes the controller core to enter Stop mode as soon as the instruction that sets the bit completes execution. In Stop mode the internal oscillator, CPU, and all digital peripherals are stopped; the state of the external oscillator circuit is not affected. Each analog peripheral (including the external oscillator circuit) may be shut down individually prior to entering Stop Mode. Stop mode can only be terminated by an internal or external reset. On reset, the device performs the normal reset sequence and begins program execution at address 0x0000.

If enabled, the Missing Clock Detector will cause an internal reset and thereby terminate the Stop mode. The Missing Clock Detector should be disabled if the CPU is to be put to in STOP mode for longer than the MCD timeout of 100 μ s.

15.3. Suspend Mode

Setting the SUSPEND bit (OSCICN.5) causes the hardware to halt the CPU and the high-frequency internal oscillator, and go into Suspend mode as soon as the instruction that sets the bit completes execution. All internal registers and memory maintain their original data. Most digital peripherals are not active in Suspend mode. The exception to this is the Port Match feature.

Suspend mode can be terminated by three types of events, a port match (described in Section "18.5. Port Match" on page 157), a Comparator low output (if enabled), or a device reset event. When Suspend mode is terminated, the device will continue execution on the instruction following the one that set the SUSPEND bit. If the wake event was configured to generate an interrupt, the interrupt will be serviced upon waking the device. If Suspend mode is terminated by an internal or external reset, the CIP-51 performs a normal reset sequence and begins program execution at address 0x0000.

Note: When entering Suspend mode, firmware must set the ZTCEN bit in REF0CN (SFR Definition 7.1).



17.2. Programmable Internal Oscillator

All C8051F54x devices include a programmable internal high-frequency oscillator that defaults as the system clock after a system reset. The internal oscillator period can be adjusted via the OSCICRS and OSCI-FIN registers defined in SFR Definition 17.3 and SFR Definition 17.4. On C8051F54x devices, OSCICRS and OSCIFIN are factory calibrated to obtain a 24 MHz base frequency. Note that the system clock may be derived from the programmed internal oscillator divided by 1, 2, 4, 8, 16, 32, 64, or 128, as defined by the IFCN bits in register OSCICN. The divide value defaults to 128 following a reset.

17.2.1. Internal Oscillator Suspend Mode

When software writes a logic 1 to SUSPEND (OSCICN.5), the internal oscillator is suspended. If the system clock is derived from the internal oscillator, the input clock to the peripheral or CIP-51 will be stopped until one of the following events occur:

- Port 0 Match Event.
- Port 1 Match Event.
- Port 2 Match Event.
- Port 3 Match Event.
- Comparator 0 enabled and output is logic 0.

When one of the oscillator awakening events occur, the internal oscillator, CIP-51, and affected peripherals resume normal operation, regardless of whether the event also causes an interrupt. The CPU resumes execution at the instruction following the write to SUSPEND.

Note: When entering suspend mode, firmware must set the ZTCEN bit in REF0CN (SFR Definition 7.1).



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Equation 17.2. C Mode Oscillator Frequency

 $f = (KF)/(R \times V_{DD})$

For example: Assume $V_{DD} = 2.1 \text{ V}$ and f = 75 kHz:

 $f = KF / (C \times VDD)$

0.075 MHz = KF / (C x 2.1)

Since the frequency of roughly 75 kHz is desired, select the K Factor from the table in SFR Definition 17.6 (OSCXCN) as KF = 7.7:

0.075 MHz = 7.7 / (C x 2.1)

C x 2.1 = 7.7 / 0.075 MHz

C = 102.6 / 2.0 pF = 51.3 pF

Therefore, the XFCN value to use in this example is 010b.



SFR Definition 18.17. P1MDIN: Port 1 Input Mode

Bit	7	6	5	4	3	2	1	0		
Name		P1MDIN[7:0]								
Туре	R/W									
Reset	1	1	1	1	1	1	1	1		

SFR Address = 0xF2; SFR Page = 0x0F

Bit	Name	Function
7:0	P1MDIN[7:0]	Analog Configuration Bits for P1.7–P1.0 (respectively).
		 Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P1MDOUT register. 0: Corresponding P1.n pin is configured for analog mode. 1: Corresponding P1.n pin is not configured for analog mode.

SFR Definition 18.18. P1MDOUT: Port 1 Output Mode

Bit	7	6	5	4	3	2	1	0				
Name	P1MDOUT[7:0]											
Туре	R/W											
Reset	0	0	0	0	0	0	0	0				

SFR Address = 0xA5; SFR Page = 0x0F

Bit	Name	Function
7:0	P1MDOUT[7:0]	Output Configuration Bits for P1.7–P1.0 (respectively).
		These bits are ignored if the corresponding bit in register P1MDIN is logic 0. 0: Corresponding P1.n Output is open-drain. 1: Corresponding P1.n Output is push-pull.



		Baud (bits/sec)														
		20 K			19.2 K			9.6 K			4.8 K			1 K		
SYSCLK (MHz)	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	Mult.	Pres.	Div.	
25	0	1	312	0	1	325	1	1	325	3	1	325	19	1	312	
24.5	0	1	306	0	1	319	1	1	319	3	1	319	19	1	306	
24	0	1	300	0	1	312	1	1	312	3	1	312	19	1	300	
22.1184	0	1	276	0	1	288	1	1	288	3	1	288	19	1	276	
16	0	1	200	0	1	208	1	1	208	3	1	208	19	1	200	
12.25	0	0	306	0	0	319	1	0	319	3	0	319	19	0	306	
12	0	0	300	0	0	312	1	0	312	3	0	312	19	0	300	
11.0592	0	0	276	0	0	288	1	0	288	3	0	288	19	0	276	
8	0	0	200	0	0	208	1	0	208	3	0	208	19	0	200	

Table 19.2. Manual Baud Rate Parameters Examples

19.2.4. Baud Rate Calculations—Automatic Mode

If the LIN controller is configured for slave mode, only the prescaler and divider need to be calculated:

prescaler =
$$\ln \left[\frac{\text{SYSCLK}}{4000000} \right] \times \frac{1}{\ln 2} - 1$$

divider =
$$\frac{\text{SYSCLK}}{2^{(\text{prescaler}+1)} \times 20000}$$

The following example calculates the values of these variables for a 24 MHz system clock:

prescaler =
$$\ln \left[\frac{24000000}{4000000} \right] \times \frac{1}{\ln 2} - 1 = 1.585 \cong 1$$

divider =
$$\frac{24000000}{2^{(1+1)} \times 20000}$$
 = 300

Table 19.3 presents some typical values of system clock and baud rate along with their factors.



LIN Register Definition 19.4. LIN0DTn: LIN0 Data Byte n

Bit	7	6	5	4	3	2	1	0			
Nam	e	DATAn[7:0]									
Type R/W											
Rese	et 0	0	0	0	0	0	0	0			
Indire LIN0D	ct Address: LIN 0T6 = 0x05, LIN	0DT1 = 0x0 0DT7 = 0x0	0, LIN0DT2)6, LIN0DT8	= 0x01, LIN(= 0x07	DT3 = 0x02	, LIN0DT4 =	0x03, LIN0[DT5 = 0x04,			
Bit	Name		Function								
7:0	DATAn[7:0]	LIN Data E	LIN Data Byte n.								
		Serial Data Byte that is received or transmitted across the LIN interface.									



Bit	Set by Hardware When:	Cleared by Hardware When:
MASTER	 A START is generated. 	A STOP is generated.Arbitration is lost.
TXMODE	 START is generated. SMB0DAT is written before the start of an SMBus frame. 	 A START is detected. Arbitration is lost. SMB0DAT is not written before the start of an SMBus frame.
STA	 A START followed by an address byte is received. 	 Must be cleared by software.
STO	 A STOP is detected while addressed as a slave. Arbitration is lost due to a detected STOP. 	 A pending STOP is generated.
ACKRQ	 A byte has been received and an ACK response value is needed. 	 After each ACK cycle.
ARBLOST	 A repeated START is detected as a MASTER when STA is low (unwanted repeated START). SCL is sensed low while attempting to generate a STOP or repeated START condition. SDA is sensed low while transmitting a 1 (excluding ACK bits). 	 Each time SI is cleared.
ACK	 The incoming ACK value is low (ACKNOWLEDGE). 	 The incoming ACK value is high (NOT ACKNOWLEDGE).
SI	 A START has been generated. Lost arbitration. A byte has been transmitted and an ACK/NACK received. A byte has been received. A START or repeated START followed by a slave address + R/W has been received. A STOP has been received. 	Must be cleared by software.

Table 20.3. Sources for Hardware Changes to SMB0CN



	Values	s Re	ad		Current SMbus State	Typical Response Options	Val Wr	lues ite	sto	s ected
Mode	Status Vector	ACKRQ	ARBLOST	ACK			STA	STO	ACK	Next Status Vector Exp
	0100	0	0	0	A slave byte was transmitted; NACK received.	No action required (expecting STOP condition).	0	0	Х	0001
-		0	0	1	A slave byte was transmitted; ACK received.	Load SMB0DAT with next data byte to transmit.	0	0	Х	0100
nsmitte		0	1	Х	A Slave byte was transmitted; error detected.	No action required (expecting Master to end transfer).	0	0	Х	0001
Image: Second			Х	An illegal STOP or bus error was detected while a Slave Transmission was in progress.	Clear STO.	0	0	Х		
	0010	1	0	Х	A slave address + R/W was received; ACK requested.	If Write, Acknowledge received address	0	0	1	0000
						If Read, Load SMB0DAT with data byte; ACK received address	0	0	1	0100
						NACK received address.	0	0	0	_
		1	1	Х	Lost arbitration as master; slave address + R/W received;	If Write, Acknowledge received address	0	0	1	0000
					ACK requested.	If Read, Load SMB0DAT with data byte; ACK received address	0	0	1	0100
						NACK received address.	0	0	0	_
						Reschedule failed transfer; NACK received address.	1	0	0	1110
	0001 0 0 X A STOP was detected while addressed as a Slave Trans mitter or Slave Receiver.		A STOP was detected while addressed as a Slave Trans- mitter or Slave Receiver.	Clear STO.	0	0	Х	_		
iver		1 1 X Lost arbitratio ing a STOP.		Lost arbitration while attempt- ing a STOP.	No action required (transfer complete/aborted).	0	0	0	_	
e Rece	0000 1 0 X A slave byte was received; ACK requested.		A slave byte was received; ACK requested.	Acknowledge received byte; Read SMB0DAT.	0	0	1	0000		
Slav						NACK received byte.	0	0	0	_

Table 20.4. SMBus Status Decoding



SFR Definition 21.3. SBUF0: Serial (UART0) Port Data Buffer

Bit	7	6	5	4	3	2	1	0			
Name	SBUF0[7:0]										
Туре	R/W										
Reset	0	0	0	0	0	0	0	0			

SFR Address = 0x99; SFR Page = 0x00

Bit	Name	Function
7:0	SBUF0[7:0]	Serial Data Buffer Bits 7–0 (MSB–LSB).
		This SFR accesses two registers; a transmit shift register and a receive latch register. When data is written to SBUF0, it goes to the transmit shift register and is held for serial transmission. Writing a byte to SBUF0 initiates the transmission. A read of SBUF0 returns the contents of the receive latch.

SFR Definition 21.4. SBCON0: UART0 Baud Rate Generator Control

Bit	7	6	5	4	3	2	1	0	
Name	Reserved	SB0RUN	Reserved	Reserved	Reserved	Reserved	SB0PS[1:0]		
Туре	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
Reset	0	0	0	0	0	0	0	0	

SFR Address = 0xAB; SFR Page = 0x0F

Bit	Name	Function
7	Reserved	Read = 0b; Must Write 0b;
6	SBORUN	Baud Rate Generator Enable.
		0: Baud Rate Generator disabled. UART0 will not function.
		1: Baud Rate Generator enabled.
5:2	Reserved	Read = 0000b; Must Write = 0000b;
1:0	SB0PS[1:0]	Baud Rate Prescaler Select.
		00: Prescaler = 12.
		01: Prescaler = 4.
		10: Prescaler = 48.
		11: Prescaler = 1.



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Figure 24.10. PCA 16-Bit PWM Mode

24.4. Watchdog Timer Mode

A programmable watchdog timer (WDT) function is available through the PCA Module 5. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH5) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

With the WDTE bit set in the PCA0MD register, Module 5 operates as a watchdog timer (WDT). The Module 5 high byte is compared to the PCA counter high byte; the Module 5 low byte holds the offset to be used when WDT updates are performed. The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled. The WDT will generate a reset shortly after code begins execution. To avoid this reset, the WDT should be explicitly disabled (and optionally re-configured and re-enabled if it is used in the system).

24.4.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS[2:0]) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 5 is forced into software timer mode.
- Writes to the Module 5 mode register (PCA0CPM5) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control bit (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH5 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH5. Upon a PCA0CPH5 write, PCA0H plus the offset held in PCA0CPL5 is loaded into PCA0CPH5 (See Figure 24.11).



SFR Definition 24.2. PCA0MD: PCA Mode

Bit	7	6	5	4	3	2	1	0			
Nam	e CIDL	WDTE	WDLCK			CPS[2:0]		ECF			
Туре	R/W	R/W	R/W	R	R/W	R/W	R/W	R/W			
Rese	t 0	1	0	0	0	0	0	0			
SFR A	ddress = 0	xD9; SFR Page	e = 0x00								
Bit	Name				Function						
7	CIDL	PCA Counter Specifies PCA 0: PCA contin 1: PCA operat	/Timer Idle behavior whues to function ion is suspe	Control. hen CPU is i on normally nded while t	in Idle Mode while the sys he system c	stem controll ontroller is in	er is in Idle I Idle Mode.	∕lode.			
6	WDTE	Watchdog Til If this bit is set 0: Watchdog T 1: PCA Modul	atchdog Timer Enable this bit is set, PCA Module 5 is used as the watchdog timer. Watchdog Timer disabled. PCA Module 5 enabled as Watchdog Timer.								
5	WDLCK	Watchdog Tin This bit locks/r Timer may not 0: Watchdog T 1: Watchdog T	Watchdog Timer Lock This bit locks/unlocks the Watchdog Timer Enable. When WDLCK is set, the Watchdog Timer may not be disabled until the next system reset. 0: Watchdog Timer Enable unlocked. 1: Watchdog Timer Enable locked.								
4	Unused	Read = 0b, W	rite = Don't c	are.							
3:1	CPS[2:0]	PCA Counter These bits sel 000: System of 001: System of 010: Timer 0 of 011: High-to-lo 100: System of 101: External 11x: Reserved	PCA Counter/Timer Pulse Select. These bits select the timebase source for the PCA counter 000: System clock divided by 12 001: System clock divided by 4 010: Timer 0 overflow 011: High-to-low transitions on ECI (max rate = system clock divided by 4) 100: System clock 101: External clock divided by 8 (synchronized with the system clock) 11x: Reserved								
0	ECF	PCA Counter This bit sets th 0: Disable the 1: Enable a Po set.	PCA Counter/Timer Overflow Interrupt Enable. This bit sets the masking of the PCA Counter/Timer Overflow (CF) interrupt. D: Disable the CF interrupt. 1: Enable a PCA Counter/Timer Overflow interrupt request when CF (PCA0CN.7) is set.								
Note:	vvnen the V contents of	the PCA0MD reg	o 1, the other b gister, the Wat	chdog Timer	AUMD register must first be c	isabled.	oaitied. To cha	inge the			





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